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Vishay General Semiconductor

High Voltage Surface-Mount Schottky Rectifier

High Barrier Technology for Improved High Temperature Performance



SMB (DO-214AA)



LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	2.0 A			
V _{RRM}	90 V, 100 V			
I _{FSM}	75 A			
V _F	0.65 V			
I _R	10 μA			
T _J max.	175 °C			
Package	SMB (DO-214AA)			
Circuit configuration	Single			

FEATURES

- Low profile package
- · Guardring for overvoltage protection
- · Ideal for automated placement
- · Low power losses, high efficiency
- Low forward voltage drop
- Low leakage current
- · High surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHE3 or P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: SMB (DO-214AA)

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade Base P/N-M3 - halogen-free, RoHS-compliant, commercial grade

Base P/NHE3_X - RoHS-compliant and AEC-Q101 qualified Base P/NHM3_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3, M3, HE3, and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

PARAMETER	SYMBOL	SS2H9	SS2H10	UNIT
Device marking code		MS9	MS10	
Maximum repetitive peak reverse voltage	V _{RRM}	90	100	V
Working peak reverse voltage	V _{RWM}	90	100	V
Maximum DC blocking voltage	V_{DC}	90	100	V
Maximum average forward rectified current at: T _L = 130 °C	I _{F(AV)}	2.0		Α
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	75		А
Peak repetitive reverse surge current at $t_p = 2.0 \mu s$, 1 kHz	I _{RRM}	1.0		Α
Voltage rate of change (rated V _R)	dV/dt	10 000		V/µs
Operating junction and storage temperature range	T _J , T _{STG}	-65 to +175		°C



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	SS2H9	SS2H10	UNIT
Maximum instantaneous forward voltage (1)	I _F = 2.0 A	T _J = 25 °C T _J = 125 °C	V _F	0.79 0.65		V
waximum instantaneous forward voitage "		T _J = 125 °C				
Maximum variance arrest at vated V (2)		T _J = 25 °C		10		μΑ
Maximum reverse current at rated V _R ⁽²⁾		T _J = 125 °C	IR	4	1	mA

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	SS2H9	SS2H10	UNIT	
Maximum thermal resistance junction-to-lead T ₁ = 25 °C ⁽¹⁾	$R_{\theta JA}$	80		°C/W	
Maximum thermal resistance junction-to-lead 1 = 25° C ***	$R_{\theta JL}$	25		C/VV	

Note

 $^{(1)}\,$ Units mounted on PCB with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
SS2H10-E3/52T	0.096	52T	750	7" diameter plastic tape and reel	
SS2H10-E3/5BT	0.096	5BT	3200	13" diameter plastic tape and reel	
SS2H10HE3_A/H (1)	0.096	Н	750	7" diameter plastic tape and reel	
SS2H10HE3_A/I (1)	0.096	I	3200	13" diameter plastic tape and reel	
SS2H10-M3/52T	0.096	52T	750	7" diameter plastic tape and reel	
SS2H10-M3/5BT	0.096	5BT	3200	13" diameter plastic tape and reel	
SS2H10HM3_A/H (1)	0.096	Н	750	7" diameter plastic tape and reel	
SS2H10HM3_A/I (1)	0.096	I	3200	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

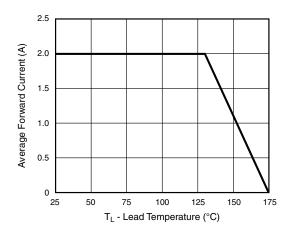


Fig. 1 - Forward Current Derating Curve

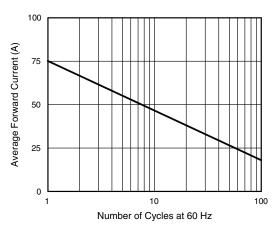


Fig. 2 - Max Non-Repetitive Peak Forward Surge Current

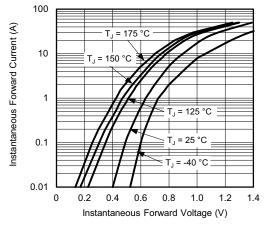


Fig. 3 - Typical Instanteous Forward Characteristics

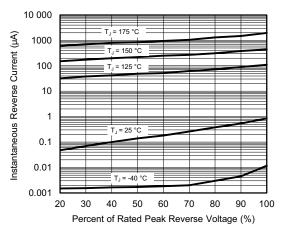


Fig. 4 - Typical Reverse Characteristics

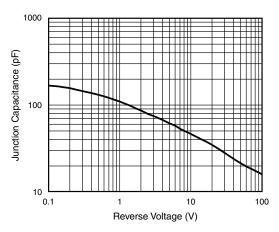


Fig. 5 - Typical Junction Capacitance

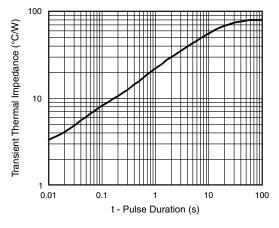


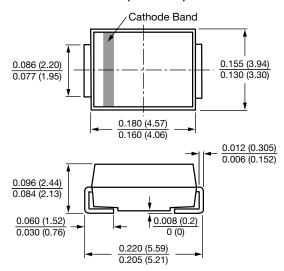
Fig. 6 - Typical Transient Thermal Impedance Per Leg



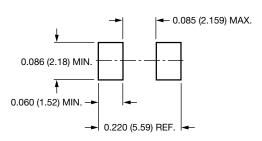
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMB (DO-214AA)



Mounting Pad Layout





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